## Interaction E ects in Conductivity of Si Inversion Layers at Interm ediate Tem peratures

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We compare the temperature dependence of resistivity (T) of SiMOSFETs with the recent theory by Zala et al. This comparison does not involve any thing parameters: the elective mass mand glactor for mobile electrons have been found independently. An anomalous increase of with temperature, which has been considered a signature of the \metallic" state, can be described quantitatively by the interaction elects in the ballistic regime. The in-plane magnetoresistance (B $_{\rm k}$ ) is qualitatively consistent with the theory; however, the lack of quantitative agreement indicates that the magnetoresistance is more susceptible to the sample-specicle ects than (T).

71.30.+ h, 73.40.Q v, 71.27.+ a

The theory of quantum corrections due to singleparticle (weak localization) and interaction e ects has been very successful in describing the low-temperature electron transport in low-dimensional conductors (see, e.g., [1]). There was, however, a noticeable exception: the tem perature- and magnetic-eld dependences of the resistivity of the most ubiquitous two-dimensional (2D) system, electrons in silicon MOSFETs, de ed the theoretical predictions. Serious quantitative discrepancies between the experim ental data and the theory of interaction corrections were noticed two decades ago (see, e.g., [2{4]). The gap between the expected and observed lowtem perature behavior of became dramatic with the advent of high-mobility Sidevices [5]. Despite the earlier attempts to attribute the \anomalousmetallic behavior" to the density-and tem perature-dependent screening [6], the low-tem perature transport in SiMOSFETs [7], as well as other 2D systems with a low carrier density n, resisted explanation for a decade (for reviews, see [8,9]).

Recently, important progress has been made in both experiment and theory, which allows to solve this long-standing problem. Firstly, it has been recognized that multiple valleys in SiMOSFETs enhance interaction effects [10,11]. Secondly, the theory of interaction corrections to the conductivity has been extended beyond the di usive regime [11]. This development is crucial because the most pronounced increase of with temperature is observed in the ballistic regime (see below). Thirdly, the Fermi-liquid interaction parameters for a dilute electron system in SiMOSFETs have been found from detailed measurements of Shubnikov-de Haas oscillations [12,13]. All this allows to compare the experimental data with the theory [11] without any adjustable parameters.

In this Letter, we show that the most prominent features of the  $\mbox{m}$  etallic" state in SiM O SFETs, the strong temperature and in-plane magnetic eld dependences (T) and (B  $_{\rm k}$ ) at relatively small resistivities  $h=e^2$ , can be accounted for by the theory [11] over a wide range of carrier densities, temperatures, and magnetic

elds. Thus, the \m etallic" conductivity of high-m obility Si M O SFETs, which was considered anomalous for a decade, can now be explained by the interaction e ects in a system with a large pseudo-spin (two valleys + two spins), and an interaction-enhanced spin susceptibility. Though the theory [11] accounts only for small corrections, it works surprisingly well for some samples even at relatively high temperatures, where = 1. The theory, however, does not agree with experiment at very low temperatures and in strong magnetic elds B  $_{\rm k}$  T = g  $_{\rm B}$ , as well as at low electron densities, where sample-specic e ects come into play [14].

The ac (13 Hz) m easurem ents of the dependences (T) and (B<sub>k</sub>) have been perform ed on six (100) SiM OS sam ples from di erent wafers: Si15 (peak mobility  $^{\rm peak}$  =  $4.0\,\mathrm{m}^2/\mathrm{V}\,\mathrm{s}$ ), Si2N i (3.4 m $^2/\mathrm{V}\,\mathrm{s}$ ), Si22 (3.3 m $^2/\mathrm{V}\,\mathrm{s}$ ), Si6-14 (2.4 m $^2/\mathrm{V}\,\mathrm{s}$ ), Si43 (1.96 m $^2/\mathrm{V}\,\mathrm{s}$ ), and Si46 (0.15 m $^2/\mathrm{V}\,\mathrm{s}$ ); m ore detailed description of the sam ples can be found in Refs. [15].

The quantum corrections to the D rude conductivity  $_{D}=e^{2}n$  =m ( is the momentum relaxation time, m is the elective mass of carriers) can be expressed (in units of  $e^{2}=h$ ) as [11,16]:

$$(T;B_k)$$
  $D = C + 15 T + 2[((E_Z;T) (0;T)] + 2[((V;T) (0;T)] + [(E_Z + V;T) (0;T)] + [$ 

Here  $_{\text{C}}=x\left[1-\frac{3}{8}f\left(x\right)\right]-\frac{1}{2}\ln\left(\frac{E_{F}}{T}\right)$  and  $_{\text{T}}=f_{1}\left(F_{0}^{a}\right)x\left[1-\frac{3}{8}t\left(x;F_{0}^{a}\right)\right]-\left(1-\frac{f}{2}\left(F_{0}^{a}\right)\right)\frac{1}{2}\ln\left(\frac{E_{F}}{T}\right)$  are the interaction contributions in the singlet and triplet channels, respectively [17];  $_{\text{loc}}\left(T\right)=\frac{1}{2}\ln\left(-r\right)$  is the weak localization contribution. The terms  $\left(Z;T\right)$ 

(0;T) reduce the triplet contribution when the Zeem an energy (Z = E<sub>Z</sub> = 2  $_{\rm B}$  B  $_{\rm k}$ ), the valley splitting (Z =  $_{\rm v}$ ), or combination of these factors (Z = E  $_{\rm Z}$   $_{\rm v}$ ) exceed the temperature. The prefactor 15 to  $_{\rm T}$  reects enhancement of the triplet contribution due to two valleys of the electron spectrum in (100) SiMOS-

FETs [10]. Because of this enhancement, the \negative" correction to the conductivity due to the triplet channel, d  $_{\rm T}$ =dT < 0, overwhelms the \positive" correction due to the singlet channel and weak localization, d( $_{\rm C}$ +  $_{\rm loc}$ )=dT > 0. The triplet-channel prefactor might be reduced by inter-valley scattering when the relevant scattering time  $_{\rm V}$  < h=T . Equation (1) describes the quantum corrections in both discusse and ballistic regimes; the crossover occurs at T (1+  $_{\rm D}^{\rm a}$ )=(2) [11].

The term  $\sin Eq. (1)$  are functions of x = T = h, Z, and  $F_0^a$ ; their explicit expressions are given in Ref. [11]. The theory [11] considers the D rude resistivity  $_{\rm D}$  = 1=  $_{\rm D}$ as a param eter and does not describe the density dependence D (n). We found D by extrapolation of the linear dependences (T) to T = 0; was determined from  $_{\rm D}$  using the renormalized e ective mass m (n) [13]. The Ferm i-liquid parameter F<sub>0</sub><sup>a</sup>  $F_0$  [18], which controls renormalization of the g-factor  $[g = g_b = (1 + F_0^a)]$ , where  $g_b = 2$  for Si], has been experimentally determined from measurements of the Shubnikov-de Haas (SdH) effect [12,13]. Throughout the paper, we accept v = 0, because sm all values  $_{\rm v}$  < 1K do not a ect the theoretical curves at interm ediate tem peratures. Thus, one can com pare the experim ent and the theoretical prediction with no adjustable parameters; such comparison is the main goal of this paper. In this important aspect, our approach diers from the attempts to determine F<sub>0</sub> for p-type GaAs [19] and SiMOSFETs [20] by tting (T) and  $(B_k)$  with the theory [11].

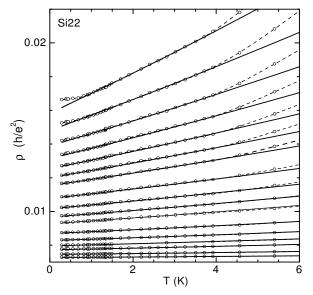


FIG.1. Resistivity at B  $_{\rm k}=0$  for sam ple Si22 vs temperature. The electron densities, from top to bottom are: n = 5.7, 6.3, 6.9, 7.5, 8.1, 8.7, 9.3, 10.5, 11.7, 12.9, 14.1, 16.5, 18.9, 21.3, 23.7, 28.5, 35.7 (in units of  $10^{11}\,{\rm cm}^{-2}$ ). D ots and dashed lines represent the data, solid lines – the theoretical curves with  $_{\rm v}=0$  and F  $_0^a$  from Ref. [13].

Figure 1 shows the resistivity of sample Si22 versus

tem perature for di erent electron densities. A linear dependence (T) extends over a decade in T, up to  $0.1E_{\rm F}$  . In this linear regime, the data almost coincide with the theoretical curves (solid lines) calculated with no adjustable param eters. Sim ilar agreem ent has been observed for samples Sil5 and Sil3. For the latter sample, the linear (T) dependences remain in agreem ent with the theory up to such high tem peratures  $0:3E_F$ ) that = 1 (see Fig. 2). In this case, which is beyond the applicability of the theoretical results [11], we still calculated the corrections to the resistivity according to  $_{\rm D}^2$  [16]. For much more disordered sample Si46, the agreement with the theory is less im pressive: the theoretical (T) curves are consistent with the data only at temperatures below 10K, which correspond for this sample mostly to the di usive regim e.

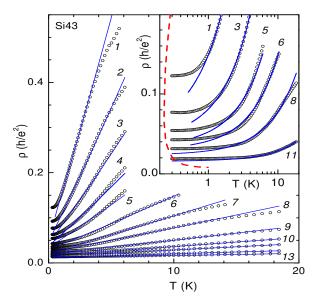


FIG. 2. (T)-dependences at B  $_{\rm k}=0$  for sam ple Si43 on the linear T-scale (main panel) and logarithm ic T-scale (insert). Dots show the data, solid lines correspond to Eq. (1) with  $_{\rm V}=0$  and F  $_0^{\rm a}$  from Ref. [13]. The densities are (in units of  $10^{11}$  cm  $^2$ ):  $1-1.49,\,2-1.67,\,3-1.85,\,4-2.07,\,5-2.30,\,6-2.75,\,7-3.19,\,8-3.64,\,9-4.54,\,10-5.43,\,11-6.33,\,12-8.13,\,13-9.91.$  The border between di usive and ballistic regim es is shown in the inset as the dashed line [11].

For all sam ples, the data agree with the theory over a broad interval of tem peratures (see Figs. 1 and 2), and depart from the theory on both sides of this interval. At high tem perature, the (T) data for Si15 and Si22 deviate from the theory up (Fig. 1), while for Si43, they deviate mostly down (Fig. 2). The non-universal deviations indicate the importance of sample-special localized states at T  $\rm E_F$ .

On the low-tem perature side, the dependences (T) tend to saturate for all sam ples, in contrast to the theo-

retical prediction Eq. (1). Weakening of the (T) dependence might be caused by a non-zero valley splitting at tem peratures T < v. Indeed, for samples Si22, Si15, and Si6-14, the saturation temperature  $(0.2 - 0.5 \, \text{K}$ , see Fig. 1) is of the order of valley splitting estimated from 0:8)K. However, for sam -SdH m easurem ents, (0:6 ple Si43, the saturation temperature is too high (1{8K, depending on the density - see Fig. 2), which makes this interpretation of the saturation dubious. It is also unlikely that the saturation at such high tem peratures could be caused by electron overheating. One of the reasons for decrease in the interaction contribution might be a strong (and sample-specic) inter-valley scattering. A theory which takes inter-valley scattering into account is currently unavailable.

Finally, we note that for lower densities and higher resistivities  $h=e^2$ , the slope d=dT changes sign. This phenomenon, known as \metal-insulator transition in 2D " (2D M II), can not be accounted for by the theory [11]; the corresponding data for samples Si43 and Si15 across the 2D M II can be found in Refs. [9,15]. Here we do not discuss this non-universal and sample-dependent regin e [14].

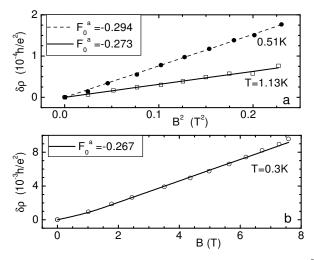


FIG .3. M agnetoresistivity for sam ple Si6-14 versus B $_k^2$  at low elds E $_z$ =T < 1 (a), and versus B $_k$  at high elds E $_z$ =T 1 (b). The electron density n = 4:94  $10^{11}$  cm  $^2$  is the same for both panels. Lines are the best ts with the F $_0^a$  values shown in the panels.

We now turn to the magnetoresistance (MR) data. In contrast to the temperature dependences of , the magnetoresistance agrees with the theory [11] only qualitatively. For this reason, in thing the experimental data, we treated  $F_0^{\,a}$  as an adjustable parameter.

Figure 3 shows that the  $F_0^a$  values, found for sample Si6-14 from thing at low (E  $_Z$  =2T < 1) and high (E  $_Z$  =2T 1) elds, agree with each other within 10%; at the sametime, these values dier by 30% from the values determined in SdH studies [13]. A similar situation

is observed for sam ple Si43 in weak and moderate elds (Fig. 4c, fand Fig. 4b,e, respectively). The weak system—atic decrease of  $\mathbf{F}_0^a$  jw ith  $\mathbf{B}_k$  in this eld range (Figs. 4) agrees qualitatively with non-linearity of magnetization which we observed in SdH measurements [13].

Fitting the weak-eld MR at dierent temperatures provides a T-dependent  $F_0^a$  (Fig. 3a). On the other hand, our SdH data for the same sample do not con m such a dependence: g m is constant within 2-3% over the same temperature range [13]. This discrepancy stems from the fact, that, according to our data (see also Ref. [3]), the experimental low-eld dependence ( $B_k$ ; T) /  $B^2$ =T with 1, diers from the theoretical one Eq. (1)].

0.5  $\delta p (h/e^2)$ 8 0 B (T) E /2T 0.1 0.2  $\delta p (10^{-3} h/e^2)$ n=1.49 20 b a = -0.3550.0 B (T)  $(E_{y}/2T)^{2}$ 0  $\delta p (10^{-3} h/e^2)$ 2 С n=1.490.00 0.02  $B^2$ 0.04  $\delta p (10^{-2}h/e^2)$ 0.1 0.2 =-0.428 d =-0.259n=4.54 8 B (T) E /2T  $\delta p (10^{-4} h/e^2)$ 0 0.5 10 n=4.54е 5 0.3 0.0 B (T)  $(E_{1}/2T)^{2}$  $\delta \rho (10^{-4} \text{h/e}^2)$ 0 0.00 0.04

F IG .4. M agnetoresistivity for sam ple Si43 vs B $_k$  and B $_k^2$  at T = 0:3K for two densities: n = 1:49  $10^{11}$  cm  $^2$  [panels a, b, c)] and 4:54  $10^{11}$  cm  $^2$  [panels d, e, f)]. The upper horizontal scales show P g  $_B$  B $_k$ =2E $_F$  on panels a and d, and E $_Z$ =2T on panels b, c, e, and f.

The discrepancy between the theory and the M R data is much more pronounced for sample Si43 in strong elds E  $_{\rm Z}$  =2T 1, where even the sign of deviations becomes density-dependent (compare Figs. 4a and 4e). The non-universal behavior of the M R has been reported earlier

for di erent sam ples [15], and even for the sam e sam – ple cooled down to  $4\,\mathrm{K}$  at di erent xed values of the gate voltage [14]. The reason for this m ight be the interaction of mobile electrons with eld-dependent and sam ple-speci c localized electron states.

The  $F_0^a$  (n) values obtained from thing the low-eld MR for three samples are summarized in Fig. 5a. The non-monotonic density dependence of  $F_0^a$  and scattering of data for dierent samples indicate that the MR is more susceptible to the sample-specice ects than (T). For comparison, we present in Fig. 5b the  $F_0^a$ -values obtained from thing of the (T) data for three samples, where we treated  $F_0^a$  as a single adjustable parameter. In contrast to Fig. 5a, there is an excellent agreement between the  $F_0^a$  values extracted from SdH measurements and from thing the (T) dependences; the agreement is observed over a wide density range n=(1.5-40)  $10^{11}$  cm  $^2$ .

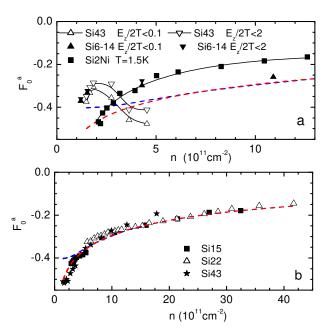


FIG.5. Comparison of  $F_0^a$  (n) values determined from : (a) tting (B<sub>k</sub>) for three samples, and (b) from tting (T) for three samples. Dashed lines depict upper and lower limits for  $F_0^a$  from SdH measurements [13].

In sum m ary, we perform ed a quantitative com parison of the (T;n) and  $(B_k;n)$  data with the theory which accounts for electron-electron interactions [11]. For highmobility sam ples, we found an excellent agreem ent (with no adjustable parameters) between (T) and the theory in the ballistic regime over a wide range of temperatures and electron densities  $n=(1.5-40)-10^{1}$  cm  $^2$ . Our experiments strongly support the theory attributing the anomalous \metallic" behavior of high-mobility SiM O SFETs [7] to the interaction elects. Non-universal (sample-dependent) deviations from the theory [11] have been observed (a) at high resistivities  $> 0.1h=e^2$ , and

(b) at low resistivities  $h\!=\!e^2$  for both the lowest temperatures and high temperatures (T  $E_F$ ). The sample-dependent deviations from the theory are more pronounced in the in-plane magnetoresistance, especially in high elds (2  $_B$  B  $_k\!=\!T$  > 1). We attribute this non-universality to interaction of the mobile electrons with eld-a ected localized electron states.

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